plerow™ ALN1883T2

Internally Matched LNA Module

Features

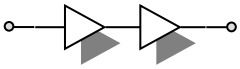
- S_{21} = 22.5 dB @ 1915 MHz
  = 23.1dB @ 1850 MHz
- NF of 0.6 dB over Frequency
- Unconditionally Stable
- Single 5V Supply
- High OIP3 @ Low Current

Description

The plerow™ ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.

RoHS-compliant





2-stage Single Type

Specifications (in Production)

Typ. @ T = 25°C, V_s = 5 V, Freq. = 1882.5 MHz, $Z_{o.sys}$ = 50 ohm

Parameter	Unit	Specifications		
		Min	Typ	Max
Frequency Range	MHz	1850		1915
Gain	dB	21.8	22.8	
Gain Flatness	dB		± 0.3	± 0.4
Noise Figure	dB		0.60	0.65
Output IP3 (1)	dBm	35	36	
S11 / S22 (2)	dB			-18 / -10
Output P1dB	dBm	20	21	
Switching Time (3)	μsec		-	
Supply Current	mA		100	120
Supply Voltage	V	5		
Impedance	Ω	50		
Max. RF Input Power	dBm	C.W 29 ~ 31 (before fail)		
Package Type & Size	mm	Surface Mount Type, 10Wx10Lx3.8H		

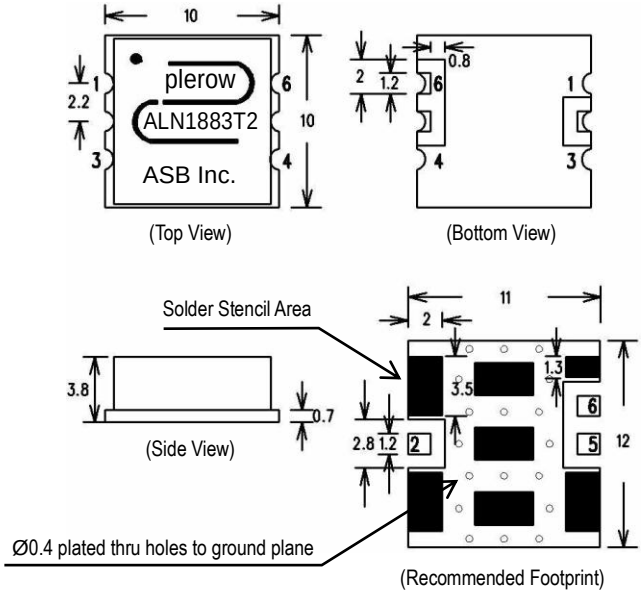
Operating temperature is -40°C to +85°C.
1) OIP3 is measured with two tones at an output power of 5 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V_S.

More Information

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Tel: (82) 42-528-7223
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Outline Drawing (Unit: mm)



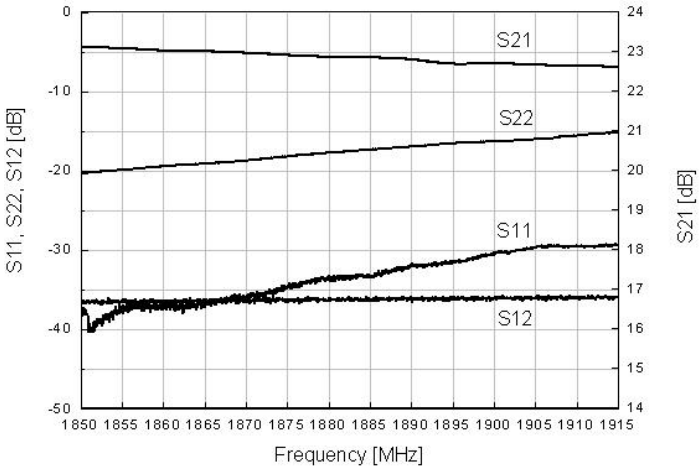
Pin Number	Function
2	RF In
5	RF Out
6	Vs
Others	Ground

Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF grounding considerations.
2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

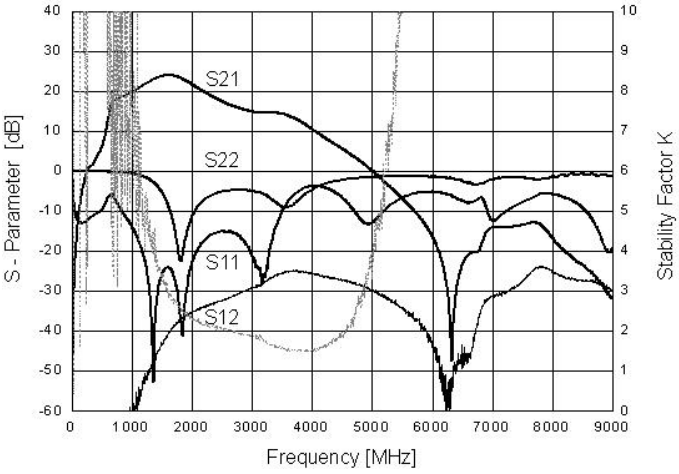
Typical Performance (Measured)

1850~1915 MHz
+5 V

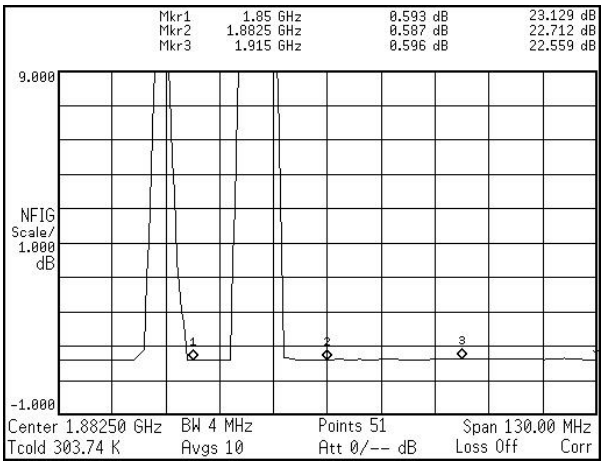
S-parameters



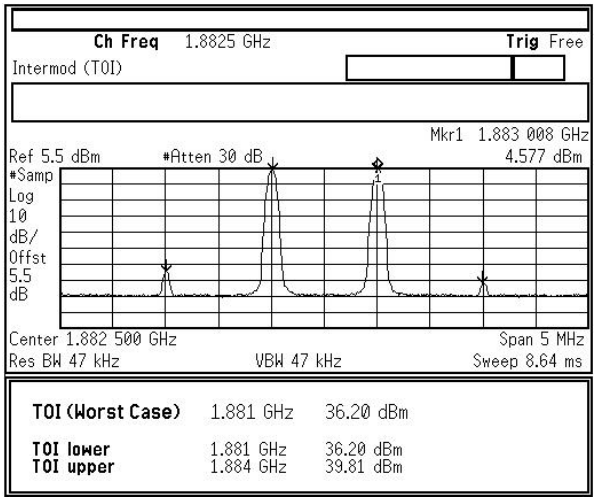
S-parameters & K Factor



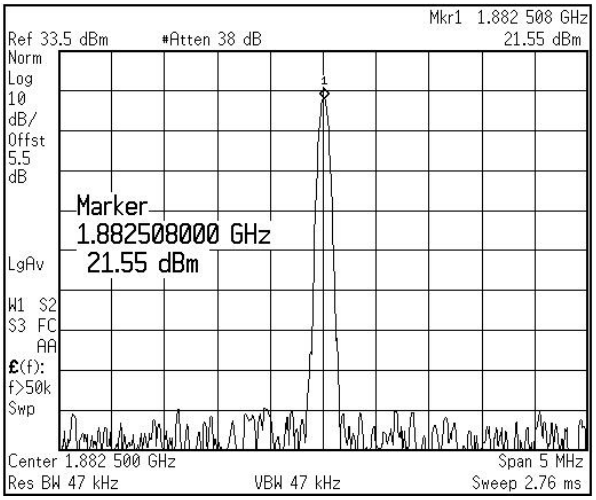
Noise Figure



OIP3



P1dB



RF Performance with Voltage Change

1. S-parameter

	1850 MHz			1882.5 MHz				1915 MHz		
	S21 (dB)	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	S11 (dB)	S22 (dB)	S21 (dB)	S11 (dB)	S22 (dB)
4.50 V	22.84	-30.67	-20.96	22.59	0.51	-31.11	-18.05	22.33	-29.45	-15.57
4.75 V	22.98	-35.10	-20.65	22.73	0.52	-32.94	-17.78	22.46	-29.60	-15.35
5.00 V	23.08	-38.10	-20.38	22.82	0.51	-33.33	-17.54	22.57	-29.27	-15.20
5.25 V	23.09	-42.00	-19.52	22.84	0.52	-32.73	-17.01	22.57	-28.90	-14.85
5.50 V	23.18	-41.67	-19.03	22.90	0.55	-32.25	-16.61	22.63	-28.45	-14.57

2. OIP3, P1dB & NF

	1850 MHz			1882.5 MHz			1915 MHz		
	OIP3 (dBm)	P1dB (dBm)	NF (dB)	OIP3 (dBm)	P1dB (dBm)	NF (dB)	OIP3 (dBm)	P1dB (dBm)	NF (dB)
4.50 V	34.46	21.84	0.583	34.47	22.37	0.589	34.10	22.72	0.592
4.75 V	36.01	22.44	0.577	36.68	22.94	0.580	36.10	23.28	0.598
5.00 V	36.20	23.01	0.590	37.47	23.53	0.585	37.76	23.90	0.602
5.25 V	35.20	23.56	0.595	36.81	24.00	0.579	38.66	24.31	0.604
5.50 V	34.14	24.05	0.603	35.75	24.38	0.616	38.95	24.64	0.604

Note: tested at room temperature.

RF Performance with Operating Temperature

1. S-parameter

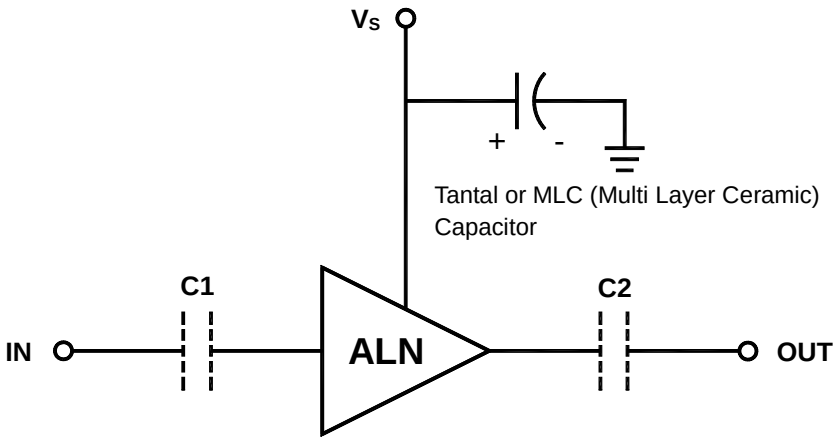
	1850 MHz			1882.5 MHz				1915 MHz		
	S21 (dB)	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	S11 (dB)	S22 (dB)	S21 (dB)	S11 (dB)	S22 (dB)
-45 °C	23.98	-26.16	-29.45	23.71	0.50	-29.07	-22.29	23.48	-36.03	-17.98
-10 °C	23.52	-27.85	-23.91	23.26	0.50	-31.29	-19.68	23.02	-42.01	-16.45
25 °C	23.09	-28.30	-21.00	22.81	0.50	-32.39	-17.75	22.58	-45.50	-15.44
60 °C	22.77	-28.93	-18.83	22.53	0.51	-32.84	-16.42	22.26	-45.86	-14.51
85 °C	22.37	-28.93	-17.47	22.32	0.50	-33.33	-15.39	21.87	-55.65	-13.83

2. OIP3, P1dB & NF

	1850 MHz			1882.5 MHz			1915 MHz		
	OIP3 (dBm)	P1dB (dBm)	NF (dB)	OIP3 (dBm)	P1dB (dBm)	NF (dB)	OIP3 (dBm)	P1dB (dBm)	NF (dB)
-45 °C	37.15	22.83	0.296	36.72	23.27	0.321	38.50	24.27	0.337
-10 °C	36.74	22.90	0.415	37.09	23.35	0.451	37.25	23.65	0.525
25 °C	36.15	23.07	0.540	37.49	23.48	0.534	36.96	23.15	0.573
60 °C	36.74	22.86	0.685	36.56	23.38	0.733	36.25	22.75	0.756
85 °C	35.18	22.40	0.983	35.10	22.79	0.893	34.85	21.42	0.998

Note: tested at V_s= 5V.

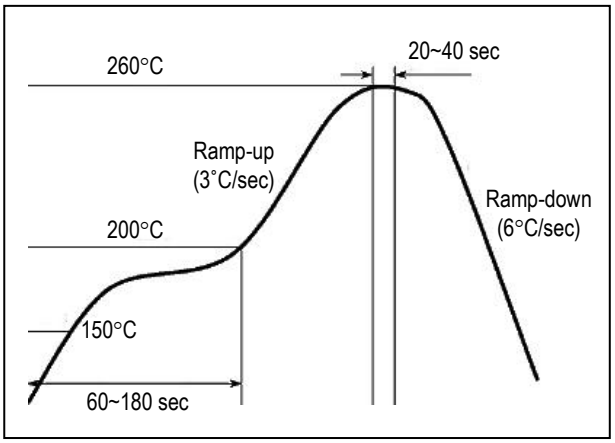
Application Circuit



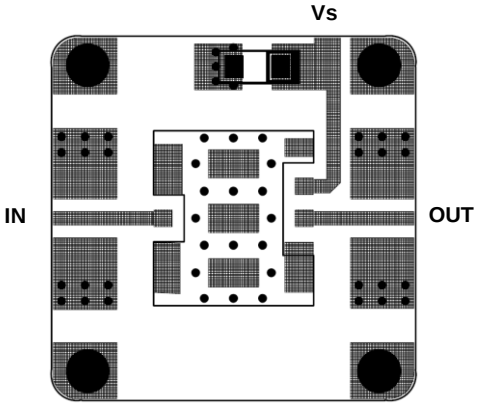
1) The tantal or MLC (Multi Layer Ceramic) capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status. The capacitor should be placed as close as possible to V_s pin and be connected directly to the ground plane for the best electrical performance.

2) DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the ALN module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

Recommended Soldering Reflow Process



Evaluation Board Layout



Size 25x25mm
(for ALN-AT, BT, T Series – 10x10mm)